

## OCTAL D-TYPE FLIP FLOP WITH 3 STATE OUTPUT NON INVERTING

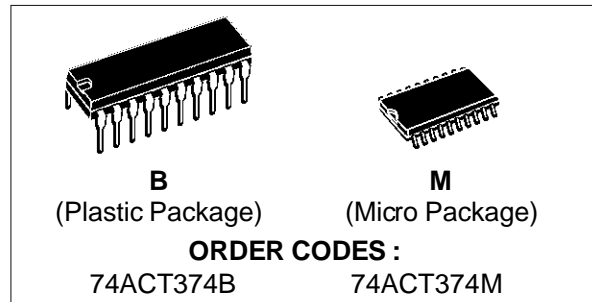
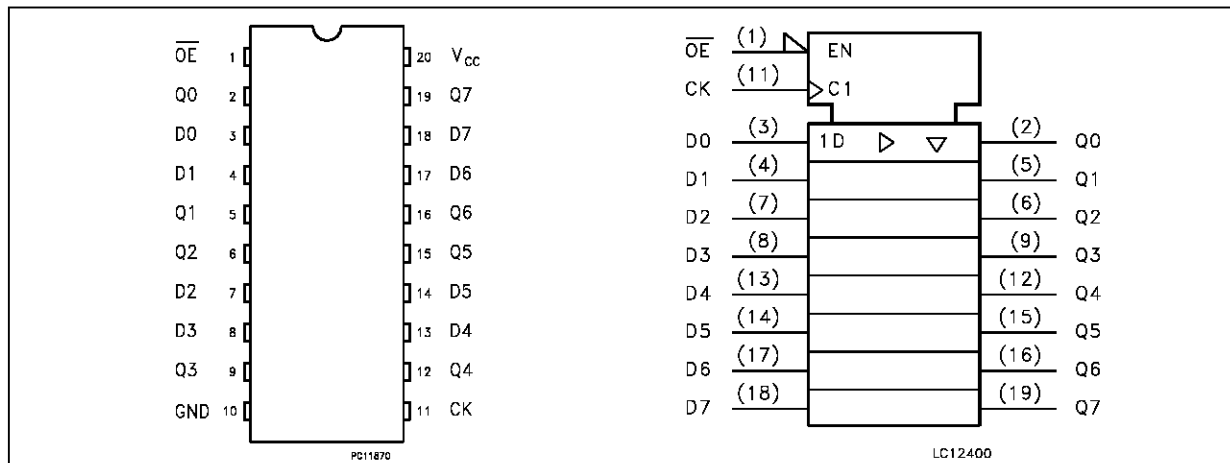
- HIGH SPEED:  
 $f_{MAX} = 260 \text{ MHz (TYP.) at } V_{CC} = 5\text{V}$
- LOW POWER DISSIPATION:  
 $I_{CC} = 8 \mu\text{A (MAX.) at } T_A = 25^\circ\text{C}$
- COMPATIBLE WITH TTL OUTPUTS  
 $V_{IH} = 2\text{V (MIN)}, V_{IL} = 0.8\text{V (MAX)}$
- 50Ω TRANSMISSION LINE DRIVING CAPABILITY
- SYMMETRICAL OUTPUT IMPEDANCE:  
 $|I_{OH}| = I_{OL} = 24 \text{ mA (MIN)}$
- BALANCED PROPAGATION DELAYS:  
 $t_{PLH} \cong t_{PHL}$
- OPERATING VOLTAGE RANGE:  
 $V_{CC} \text{ (OPR)} = 4.5\text{V to } 5.5\text{V}$
- PIN AND FUNCTION COMPATIBLE WITH 74 SERIES 374
- IMPROVED LATCH-UP IMMUNITY

### DESCRIPTION

The ACT374 is an advanced high-speed CMOS OCTAL D-TYPE FLIP FLOP with 3 STATE OUTPUT NON INVERTING fabricated with sub-micron silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology. It is ideal for low power applications maintaining high speed operation similar to equivalent Bipolar Schottky TTL.

These 8 bit D-Type flip-flops are controlled by a clock input (CK) and an output enable input (OE).

### PIN CONNECTION AND IEC LOGIC SYMBOLS



On the positive transition of the clock, the Q outputs will be set to logic state that were setup at the D inputs.

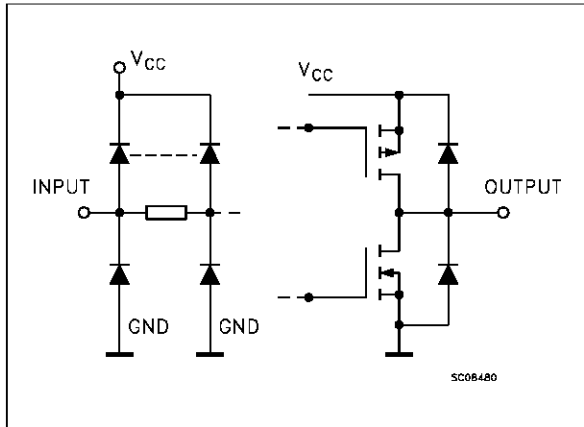
While the  $\overline{OE}$  input is low, the 8 outputs will be in a normal logic state (high or low logic level) and while high level the outputs will be in a high impedance state.

The output control does not affect the internal operation of flip flop; that is, the old data can be retained or the new data can be entered even while the outputs are off.

The device is designed to interface directly High Speed CMOS system with TTL and NMOS components.

All inputs and outputs are equipped with protection circuits against static discharge, giving them 2KV ESD immunity and transient excess voltage.

INPUT AND OUTPUT EQUIVALENT CIRCUIT



PIN DESCRIPTION

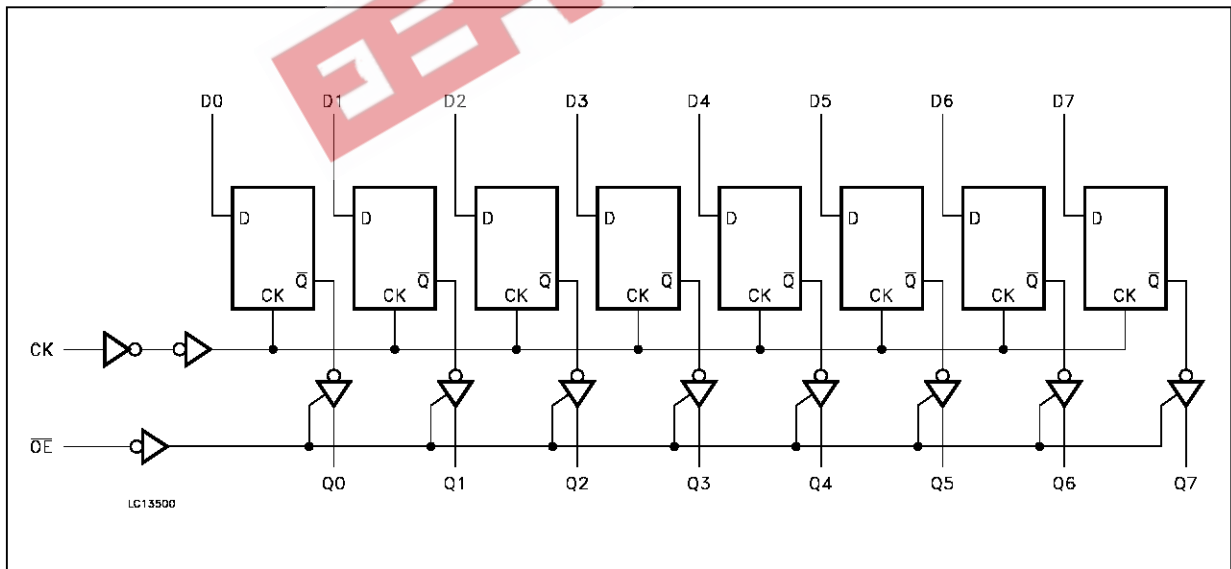
PIN No	SYMBOL	NAME AND FUNCTION
1	$\overline{OE}$	3 State Output Enable Input (Active LOW)
2, 5, 6, 9, 12, 15, 16, 19	Q0 to Q7	3 State Outputs
3, 4, 7, 8, 13, 14, 17, 18	D0 to D7	Data Inputs
11	CLOCK	Clock Input (LOW to HIGH, edge triggered)
10	GND	Ground (0V)
20	Vcc	Positive Supply Voltage

TRUTH TABLE

$\overline{OE}$	INPUTS		OUTPUTS
	CK	D	Q
H	X	X	Z
L		X	NO CHANGE
L		L	L
L		H	H

X: DON'T CARE  
Z: HIGH IMPEDANCE

LOGIC DIAGRAMS



**ABSOLUTE MAXIMUM RATINGS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	-0.5 to +7	V
V <sub>I</sub>	DC Input Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
V <sub>O</sub>	DC Output Voltage	-0.5 to V <sub>CC</sub> + 0.5	V
I <sub>IK</sub>	DC Input Diode Current	± 20	mA
I <sub>OK</sub>	DC Output Diode Current	± 20	mA
I <sub>O</sub>	DC Output Current	± 50	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current	± 400	mA
T <sub>stg</sub>	Storage Temperature	-65 to +150	°C
T <sub>L</sub>	Lead Temperature (10 sec)	300	°C

Absolute Maximum Ratings are those values beyond which damage to the device may occur. Functional operation under these condition is not implied.

**RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Value	Unit
V <sub>CC</sub>	Supply Voltage	4.5 to 5.5	V
V <sub>I</sub>	Input Voltage	0 to V <sub>CC</sub>	V
V <sub>O</sub>	Output Voltage	0 to V <sub>CC</sub>	V
T <sub>op</sub>	Operating Temperature:	-40 to +85	°C
dt/dv	Input Rise and Fall Time V <sub>CC</sub> = 4.5 to 5.5V (note 1)	8	ns/V

1) V<sub>IN</sub> from 0.8 V to 2.0 V

## DC SPECIFICATIONS

Symbol	Parameter	Test Conditions		Value					Unit
		V <sub>CC</sub> (V)		T <sub>A</sub> = 25 °C			-40 to 85 °C		
				Min.	Typ.	Max.	Min.	Max.	
V <sub>IH</sub>	High Level Input Voltage	4.5	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V	2.0	1.5		2.0		V
		5.5		2.0	1.5		2.0		
V <sub>IL</sub>	Low Level Input Voltage	4.5	V <sub>O</sub> = 0.1 V or V <sub>CC</sub> - 0.1 V		1.5	0.8		0.8	V
		5.5			1.5	0.8		0.8	
V <sub>OH</sub>	High Level Output Voltage	4.5	V <sub>I</sub> (*) = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = -50 μA	4.4	4.49		4.4	V
		5.5		I <sub>O</sub> = -50 μA	5.4	5.49		5.4	
		4.5		I <sub>O</sub> = -24 mA	3.86			3.76	
		5.5		I <sub>O</sub> = -24 mA	4.86			4.76	
V <sub>OL</sub>	Low Level Output Voltage	4.5	V <sub>I</sub> (*) = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>O</sub> = 50 μA		0.001	0.1	0.1	V
		5.5		I <sub>O</sub> = 50 mA		0.001	0.1	0.1	
		4.5		I <sub>O</sub> = 24 mA			0.36	0.44	
		5.5		I <sub>O</sub> = 24 mA			0.36	0.44	
I <sub>I</sub>	Input Leakage Current	5.5	V <sub>I</sub> = V <sub>CC</sub> or GND			±0.1		±1	μA
I <sub>OZ</sub>	3 State Output Leakage Current	5.5	V <sub>I</sub> = V <sub>IH</sub> or V <sub>IL</sub> V <sub>O</sub> = V <sub>CC</sub> or GND			±0.5		±5	μA
I <sub>CC1</sub>	Max I <sub>CC</sub> /Input	5.5	V <sub>I</sub> = V <sub>CC</sub> - 2.1 V		0.6			1.5	mA
I <sub>CC</sub>	Quiescent Supply Current	5.5	V <sub>I</sub> = V <sub>CC</sub> or GND			8		80	μA
I <sub>OLD</sub>	Dynamic Output Current (note 1, 2)	5.5	V <sub>OLD</sub> = 1.65 V max					75	mA
I <sub>OHD</sub>			V <sub>OHD</sub> = 3.85 V min					-75	mA

1) Maximum test duration 2ms, one output loaded at time

2) Incident wave switching is guaranteed on transmission lines with impedances as low as 50 Ω.

(\*) All outputs loaded.

**AC ELECTRICAL CHARACTERISTICS** ( $C_L = 50 \text{ pF}$ ,  $R_L = 500 \Omega$ , Input  $t_r = t_f = 3 \text{ ns}$ )

Symbol	Parameter	Test Condition		Value					Unit	
				V <sub>CC</sub> (V)	T <sub>A</sub> = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.		Max.
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay Time CK to Q	5.0 <sup>(*)</sup>		5.0	10.0		11.0	ns		
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time	5.0 <sup>(*)</sup>		6.0	10.0		11.0	ns		
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time	5.0 <sup>(*)</sup>		6.5	10.0		11.0	ns		
t <sub>w</sub>	CK Pulse Width, HIGH or LOW	5.0 <sup>(*)</sup>		1.5	5.0		5.0	ns		
t <sub>s</sub>	Setup Time Q to CK HIGH or LOW	5.0 <sup>(*)</sup>		0.5	5.0		5.0	ns		
t <sub>h</sub>	Hold Time Q to CK HIGH or LOW	5.0 <sup>(*)</sup>		-0.5	2.0		2.0	ns		
f <sub>MAX</sub>	Maximim Clock Frequency	5.0 <sup>(*)</sup>		100	260		85	MHz		

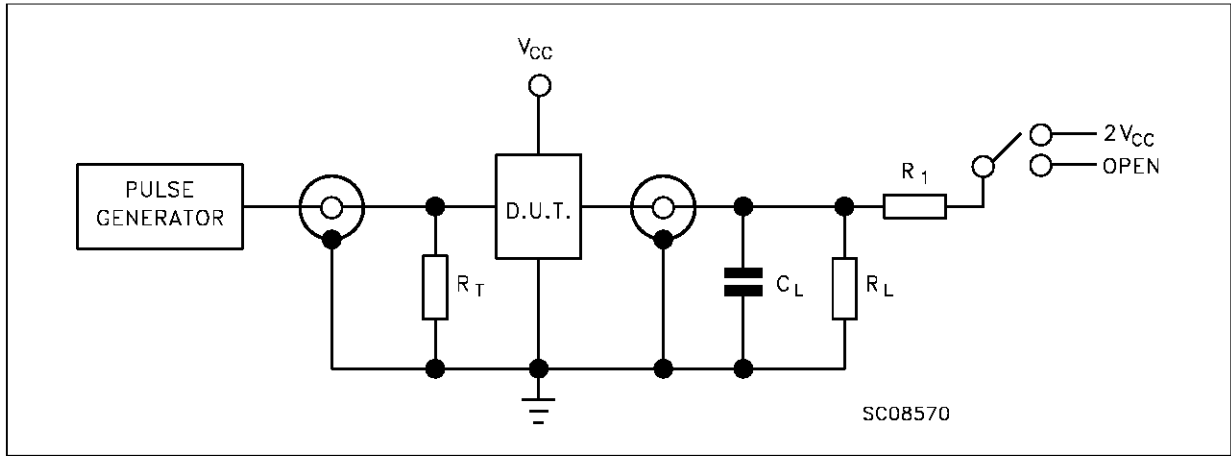
(\*) Voltage range is 5V ± 0.5V

**CAPACITIVE CHARACTERISTICS**

Symbol	Parameter	Test Conditions		Value					Unit	
				V <sub>CC</sub> (V)	T <sub>A</sub> = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.		Max.
C <sub>OUT</sub>	Output Capacitance	5.0		8				pF		
C <sub>IN</sub>	Input Capacitance	5.0		4				pF		
C <sub>PD</sub>	Power Dissipation Capacitance (note 1)	5.0		25				pF		

1) C<sub>PD</sub> is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average operating current can be obtained by the following equation.  $I_{CC}(opr) = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/n$  (per circuit)

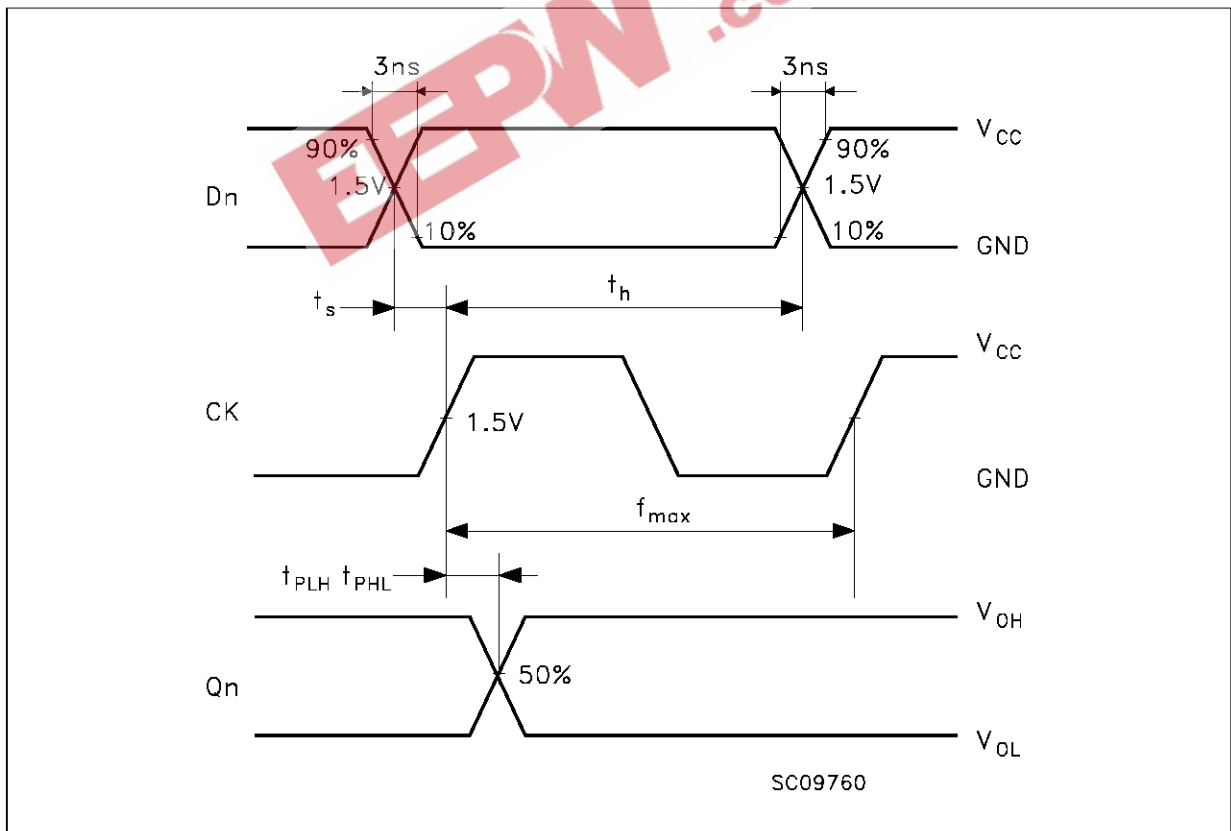
TEST CIRCUIT

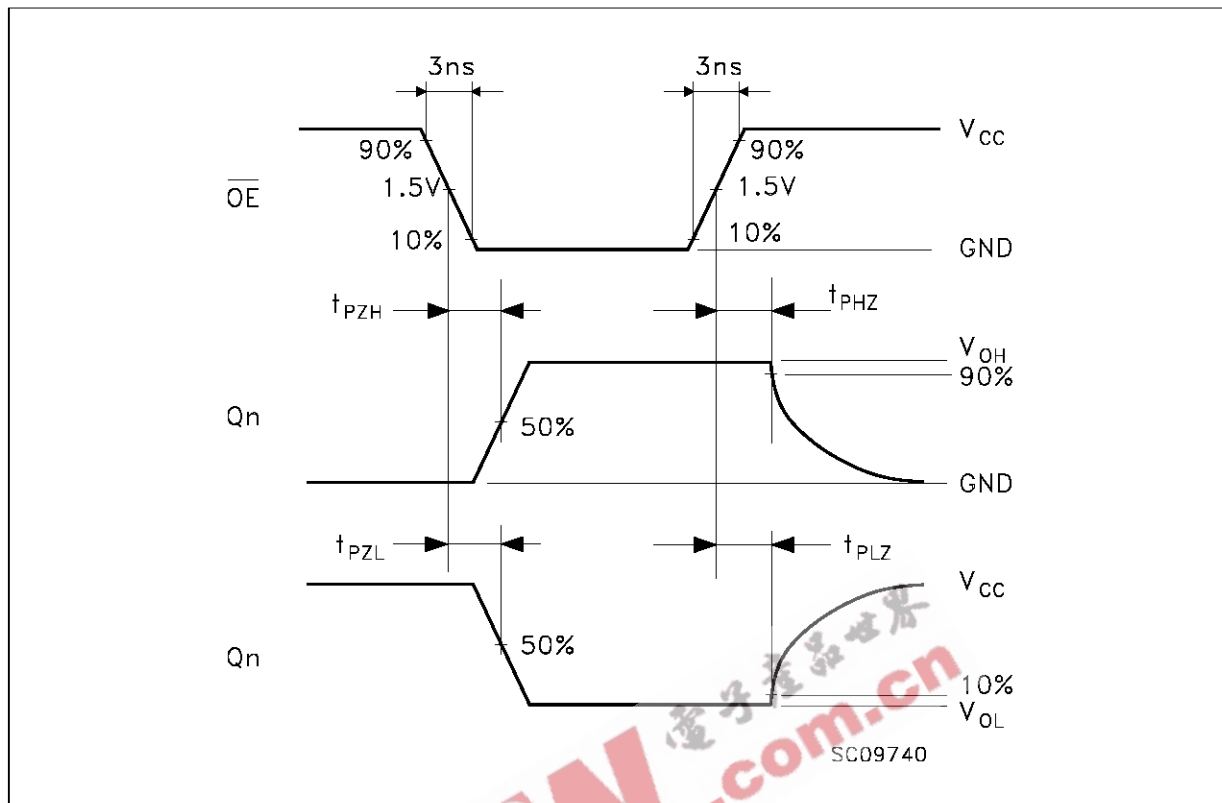
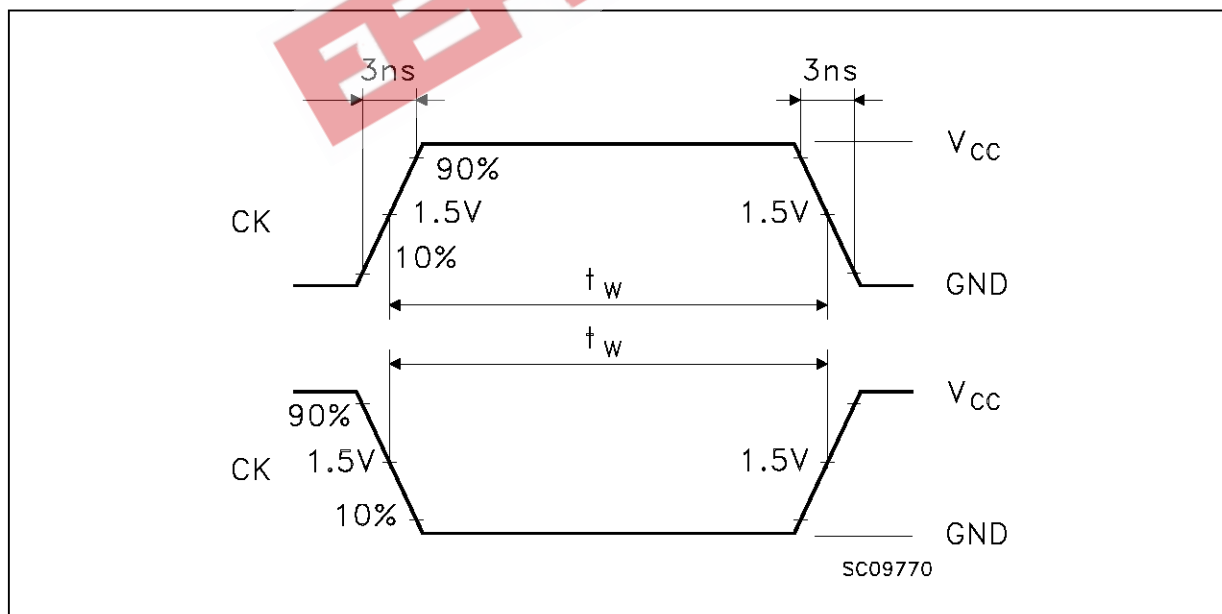


TEST	SWITCH
$t_{PLH}$ , $t_{PHL}$	Open
$t_{PZL}$ , $t_{PLZ}$	$2V_{CC}$
$t_{PZH}$ , $t_{PHZ}$	Open

$C_L$  = 50 pF or equivalent (includes jig and probe capacitance)  
 $R_L = R_1$  = 500Ω or equivalent  
 $R_T$  =  $Z_{out}$  of pulse generator (typically 50Ω)

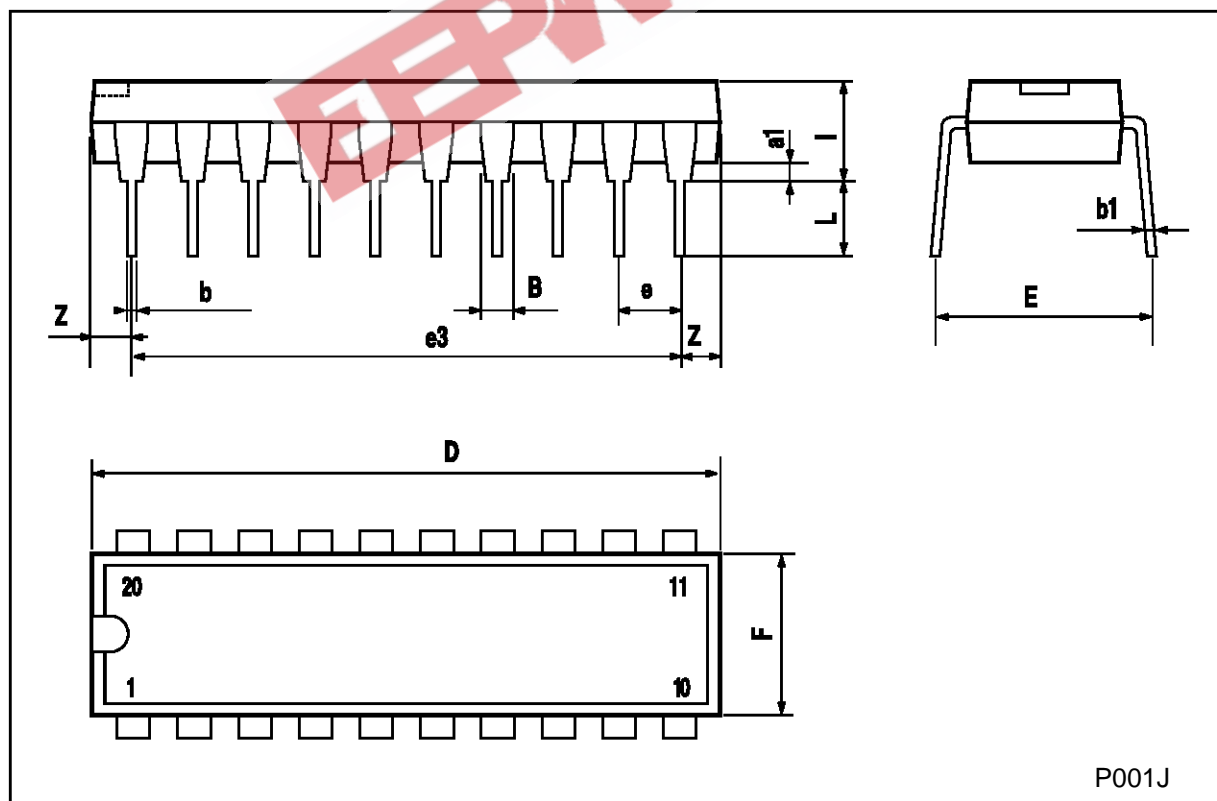
WAVEFORM 1: PROPAGATION DELAYS, SETUP AND HOLD TIMES ( $f=1\text{MHz}$ ; 50% duty cycle)



**WAVEFORM 2: OUTPUT ENABLE AND DISABLE TIMES** ( $f=1\text{MHz}$ ; 50% duty cycle)

**WAVEFORM 3: PULSE WIDTH**


## Plastic DIP20 (0.25) MECHANICAL DATA

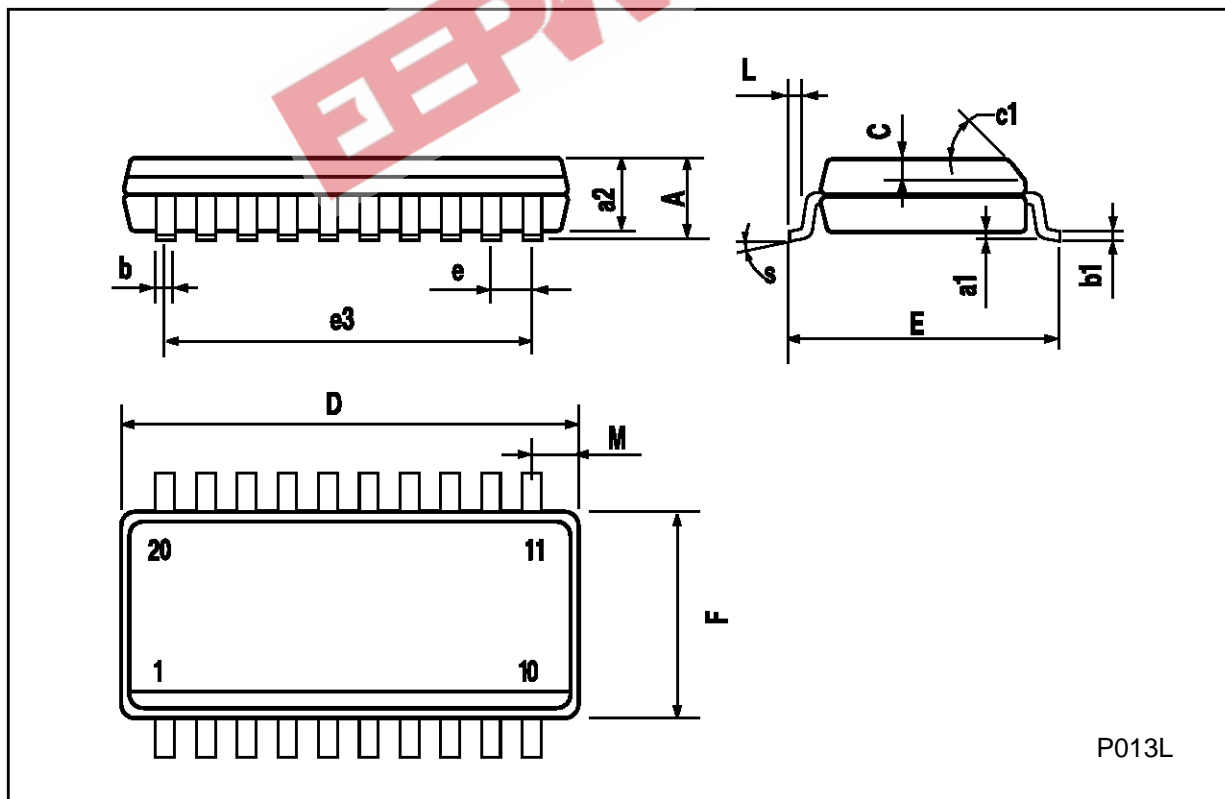
DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
a1	0.254			0.010		
B	1.39		1.65	0.055		0.065
b		0.45			0.018	
b1		0.25			0.010	
D			25.4			1.000
E		8.5			0.335	
e		2.54			0.100	
e3		22.86			0.900	
F			7.1			0.280
l			3.93			0.155
L		3.3			0.130	
Z			1.34			0.053





## SO20 MECHANICAL DATA

DIM.	mm			inch		
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
A			2.65			0.104
a1	0.10		0.20	0.004		0.007
a2			2.45			0.096
b	0.35		0.49	0.013		0.019
b1	0.23		0.32	0.009		0.012
C		0.50			0.020	
c1	45° (typ.)					
D	12.60		13.00	0.496		0.512
E	10.00		10.65	0.393		0.419
e		1.27			0.050	
e3		11.43			0.450	
F	7.40		7.60	0.291		0.299
L	0.50		1.27	0.19		0.050
M			0.75			0.029
S	8° (max.)					





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